

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MIKIYA ICHIMURA	03/28/2018
SOTA MAEHARA	03/28/2018
YOSHITAKA KURAOKA	03/28/2018
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15965014
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ATTORNEY DOCKET NUMBER:	5729.P0002US
NAME OF SUBMITTER:	TERRYENCE F. CHAPMAN
SIGNATURE:	/Terryence F. Chapman/
DATE SIGNED:	04/27/2018
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	
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Attorney Docket No.: _____

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET, AND ASSIGNMENT	
Title of Invention: 発明の名称:	EPITAXIAL SUBSTRATE FOR SEMICONDUCTOR ELEMENTS, SEMICONDUCTOR ELEMENT, AND MANUFACTURING METHOD FOR EPITAXIAL SUBSTRATES FOR SEMICONDUCTOR ELEMENTS
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to:</p> <p><input checked="" type="checkbox"/> The attached application, or</p> <p><input type="checkbox"/> United States application or PCT International Application Number _____ filed on _____.</p> <p>The above identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p>	<p>私は、以下に記名された発明者として、ここに下記の 通り宣言する:</p> <p>本宣言は以下に対するものである:</p> <p><input type="checkbox"/> 添付出願書または</p> <p><input type="checkbox"/> _____の日に提出された米国 出願番号または PCT 国際出願番号 _____の出願書。</p> <p>上記の特定の出願は私または私の承認によって行われ たものである。</p> <p>私は出願書において特許請求している発明の最初の発 明者または最初の共同発明者であると信じている。</p> <p>私は本宣言における故意の虚偽の記載は米国法典第 18 編第 1001 条に基づき、罰金または五（５）年以下の懲 役、もしくはその両方によって処罰されることがある ことを承認する。</p>
<p>ASSIGNMENT: In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to</p>	<p>譲渡証: 各々の署名人に対して支払われた総額 1 ドル (\$ 1.00) および他の適切な有価約因を考慮して、本 署名人（ら）は、</p>
<p>Name of Assignee: 譲受人の名称:</p> <p>Address of Assignee: 譲受人のアドレス:</p>	<p>NGK INSULATORS, LTD.</p> <p>2-56, Suda-cho, Mizuho-ku, Nagoya-shi, Aichi 4678530, Japan</p>
<p>(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention, and all applications for patent and any Letters Patent which may be granted therefor for which the undersigned have executed an application for patent in the United States of America.</p>	<p>(以下、譲受人と称する)に対して、譲渡に同意し、本 発明および特許のための全ての出願、署名人がアメリ カ合衆国において特許出願を行い付与された全ての特 許証における、アメリカ合衆国ならびにその領土、属 領、財産のための全ての権利、所有権、および利権を 譲受人に移転および譲渡する。</p>

Legal Name of Inventor/Assignor Mikiya ICHIMURA 発明者/譲渡人の氏名	
Inventor/Assignor: <u>Mikiya Ichimura</u>	Date: <u>March 28, 2018</u>
発明者/譲渡人: _____	日付: _____
Legal Name of Inventor/Assignor Sota MAEHARA 発明者/譲渡人の氏名	
Inventor/Assignor: <u>Sota Maehara</u>	Date: <u>March 28, 2018</u>
発明者/譲渡人: _____	日付: _____
Legal Name of Inventor/Assignor Yoshitaka KURAOKA 発明者/譲渡人の氏名	
Inventor/Assignor: <u>Yoshitaka Kuraoka</u>	Date: <u>March 28, 2018</u>
発明者/譲渡人: _____	日付: _____
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名	
Inventor/Assignor: _____	Date: _____
発明者/譲渡人: _____	日付: _____
Legal Name of Inventor/Assignor 発明者/譲渡人の氏名	
Inventor/Assignor: _____	Date: _____
発明者/譲渡人: _____	日付: _____
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Inventor/Assignor: _____	Date: _____
発明者/譲渡人: _____	日付: _____